

# Nlps Thyristor/Diode Modules MD1000TH\*\*W MR1000TH\*\*W MC1000TH\*\*W

## Features:

- Isolated mounting base 2500V~
- Pressure contact technology with Increased power cycling capability
- Space and weight saving

## Typical Applications

- AC/DC Motor drives
- Various rectifiers
- DC supply for PWM inverter

V <sub>DSM</sub> , V <sub>RSM</sub>	V <sub>DRM</sub> , V <sub>RDM</sub>	品名
900V	800V	Mx1000TH80W
1100V	1000V	Mx1000TH100W
1300V	1200V	Mx1000TH120W
1500V	1400V	Mx1000TH140W
1700V	1600V	Mx1000TH160W
1900V	1800V	Mx1000TH180W

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T <sub>j</sub> (°C)	VALUE			UNIT
				Min.	Typ.	Max.	
I <sub>T(AV)</sub>	Mean on-state current	180° half sine wave 50Hz Single side cooled, T <sub>c</sub> =55°C	125			1000	A
I <sub>T(RMS)</sub>	RMS on-state current					1570	A
I <sub>DRM</sub> I <sub>RDM</sub>	Repetitive peak current	at V <sub>DRM</sub> at V <sub>RDM</sub>	125			55	mA
I <sub>TSM</sub>	Surge on-state current	10ms half sine wave, V <sub>R</sub> =0.6V <sub>RDM</sub>	125			26.0	kA
I <sup>2</sup> t	I <sup>2</sup> t for fusing coordination					3380	A <sup>2</sup> s*10 <sup>3</sup>
V <sub>TO</sub>	Threshold voltage		125			0.81	V
r <sub>T</sub>	On-state slope resistance					0.21	mΩ
V <sub>TM</sub>	Peak on-state voltage	I <sub>TM</sub> =3000A	25			2.05	V
dv/dt	Critical rate of rise of off-state voltage	V <sub>DM</sub> =67%V <sub>DRM</sub>	125			800	V/μs
di/dt	Critical rate of rise of on-state current	Gate source 1.5A t <sub>r</sub> ≤0.5μs Repetitive	125			100	A/μs
I <sub>GT</sub>	Gate trigger current	V <sub>A</sub> =12V, I <sub>A</sub> =1A	25	30		200	mA
V <sub>GT</sub>	Gate trigger voltage			0.8		3.0	V
I <sub>H</sub>	Holding current			10		200	mA
V <sub>GD</sub>	Non-trigger gate voltage	V <sub>DM</sub> =67%V <sub>DRM</sub>	125	0.2			V
I <sub>GD</sub>	Non-trigger gate current	V <sub>DM</sub> =67%V <sub>DRM</sub>	125	1.5			mA
R <sub>th(j-c)</sub>	Thermal resistance Junction to case	D.C. Single side cooled per chip				0.052	°C /W
R <sub>th(c-h)</sub>	Thermal resistance case to heat sink	D.C. Single side cooled per chip				0.037	°C /W
V <sub>iso</sub>	Isolation voltage	50Hz, R.M.S, t=1min, I <sub>iso</sub> : 1mA(MAX)		2500			V
F <sub>m</sub>	Terminal connection torque(M12)				14.0		N·m
	Mounting torque(M8)				12.0		N·m
T <sub>vj</sub>	Junction temperature			-40		125	°C
T <sub>stg</sub>	Stored temperature			-40		125	°C
W <sub>t</sub>	Weight				3460		g
Outline	M15						

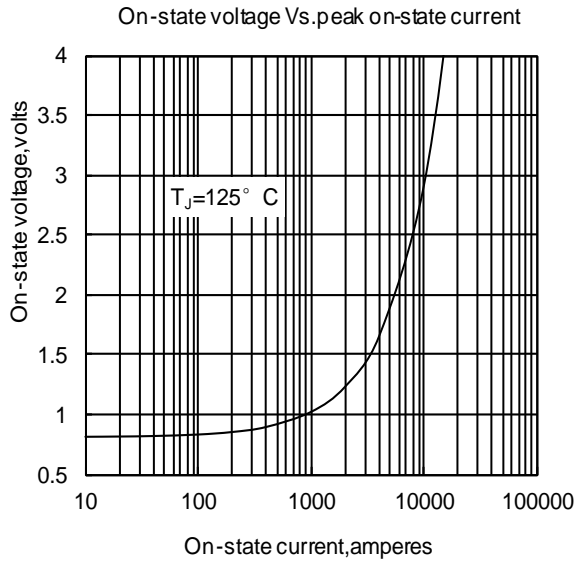


Fig1

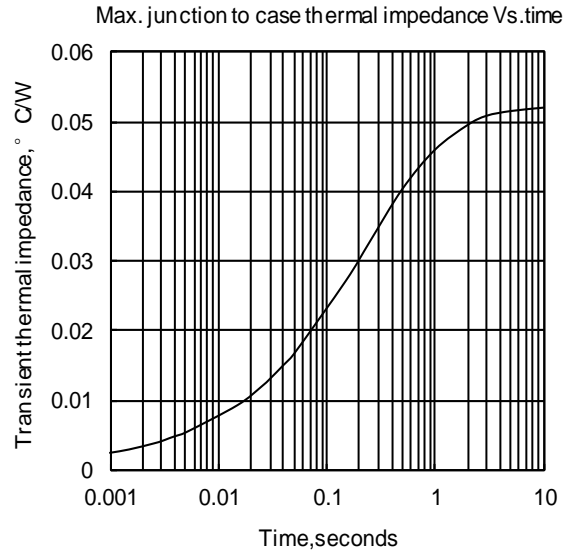


Fig2

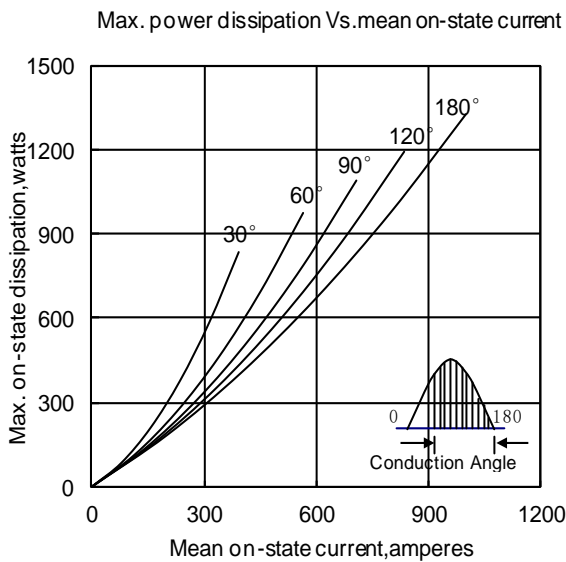


Fig3

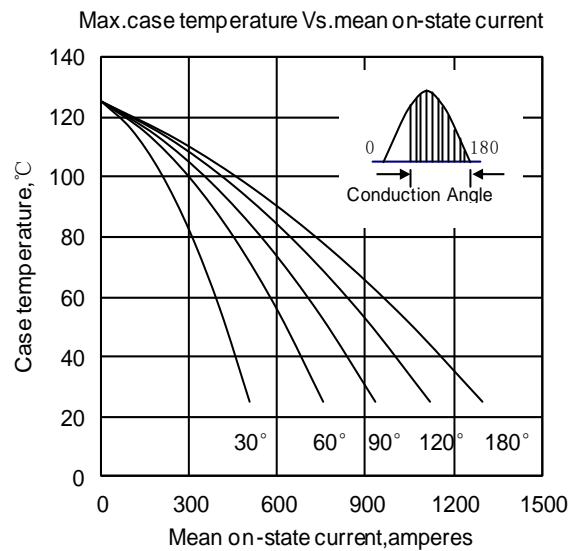


Fig4

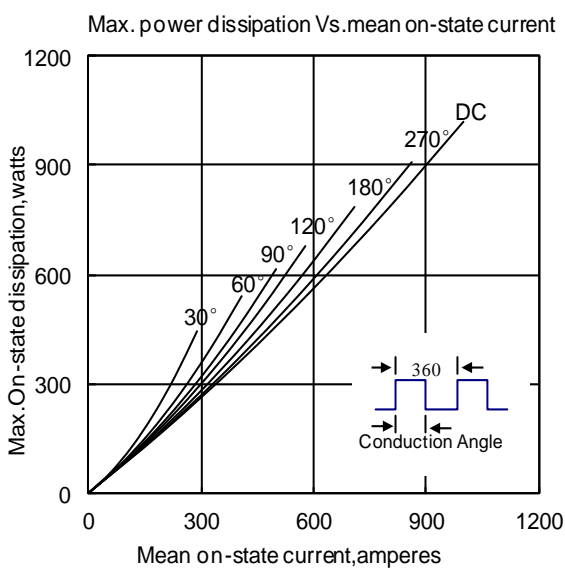


Fig5

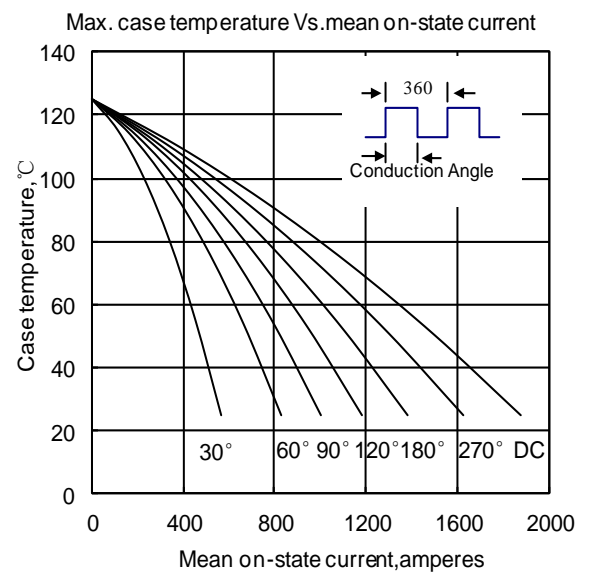


Fig6

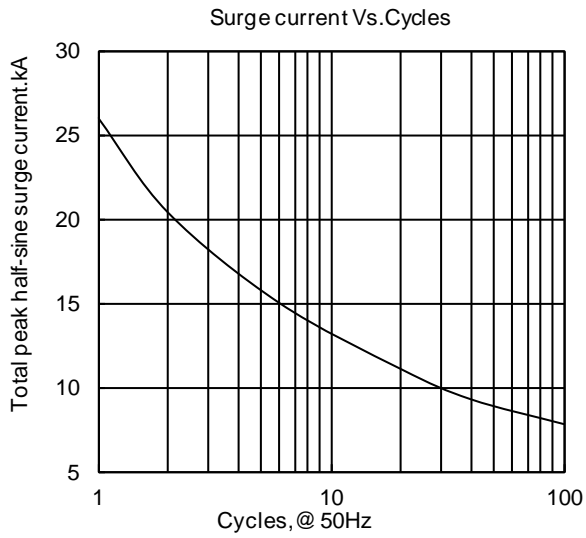


Fig7

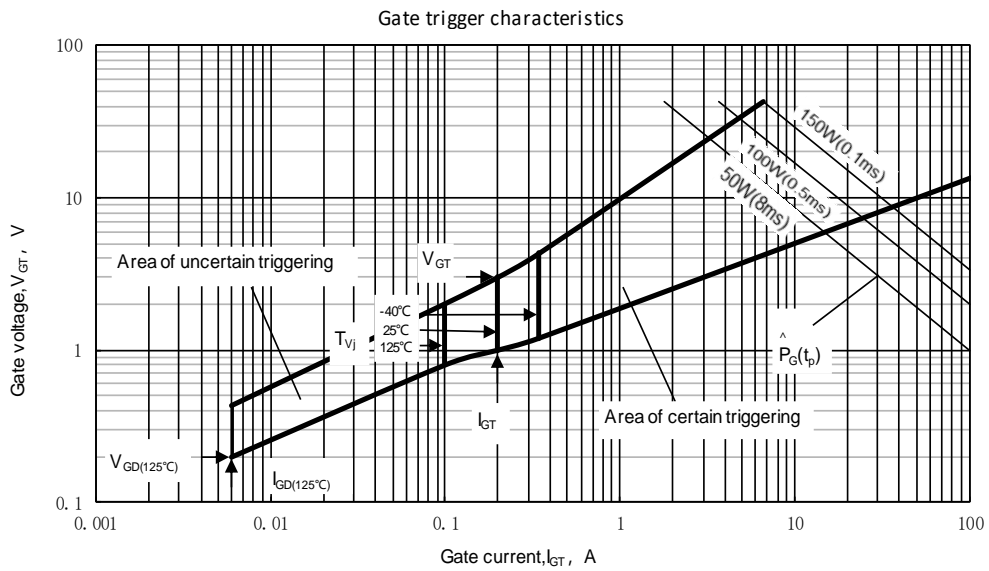


Fig8

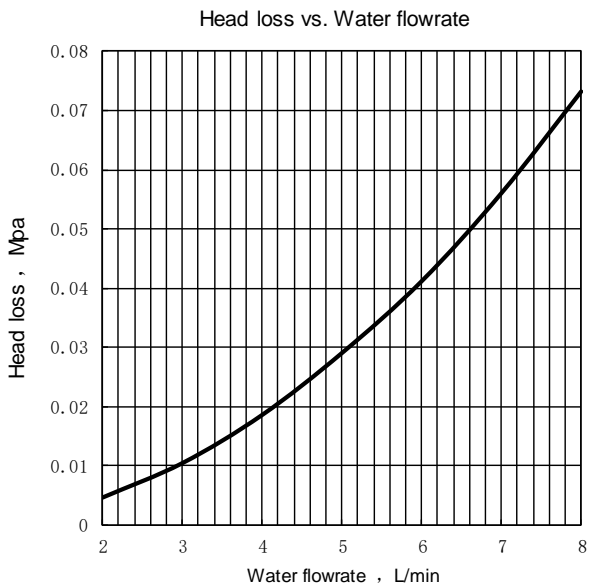


Fig9

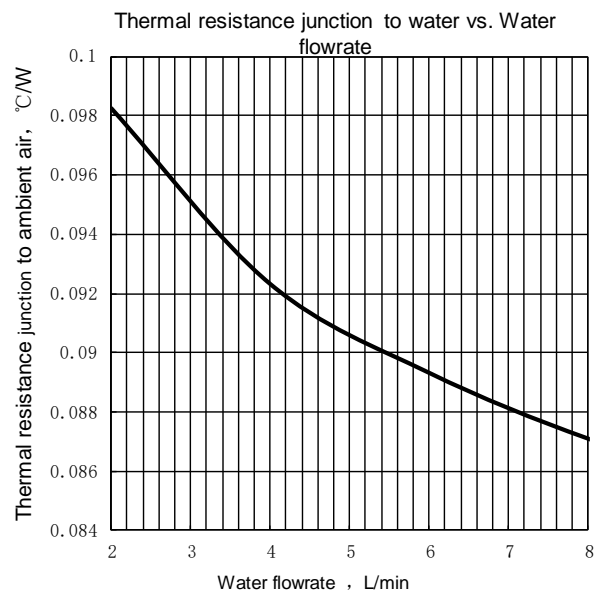
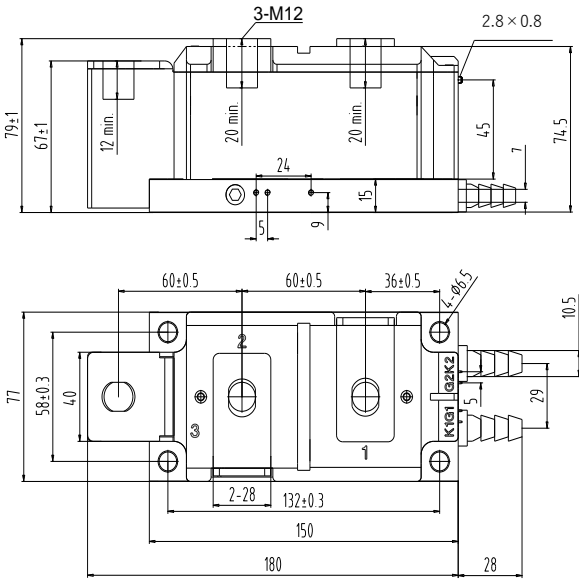


Fig.10

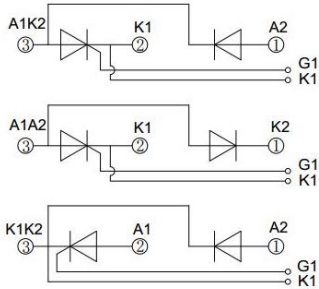
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Unmarked dimensional tolerance : ±0.5mm

Nlps reserves the right to change specifications without notice.